



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at
www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.



July 2014

FOD8160

High Noise Immunity, 3.3 V / 5 V, 10 Mbit/sec, Logic Gate Optocoupler in Wide-Body SOP 5-Pin

Features

- Optoplanar® Packaging Technology Allows More Than 10 mm Creepage and Clearance Distance, and 0.5 mm Insulation Distance to Achieve Reliable and High Voltage Insulation
- High Noise Immunity Characterized by Common Mode Transient Immunity (CMTI)
 - 20 kV/μs Minimum CMTI
- Specifications Guaranteed Over 3 V to 5.5 V Supply Voltage and -40°C to 100°C Extended Industrial Temperature Range
- High-Speed, 10 Mbit/s Data Rate (NRZ)
- Safety and Regulatory Approvals
 - UL1577, 5,000 VAC_{RMS} for 1 Minute
 - DIN-EN/IEC60747-5-5, 1,414 V Peak Working Insulation Voltage

Applications

- Isolating Intelligent Power Module
- Isolating Industrial Communication Interface

Related Resources

- www.fairchildsemi.com/products/opto/
- www.fairchildsemi.com/pf/FO/FODM8061.html
- www.fairchildsemi.com/pf/FO/FODM611.html

Description

The FOD8160 is a 3.3 V / 5 V high-speed logic gate optocoupler with open-collector output, which supports isolated communications to allow digital signals to communicate between systems without conducting ground loops or hazardous voltages. The device utilizes Fairchild's proprietary Optoplanar® coplanar packaging technology and optimized IC design to achieve high-noise immunity, characterized by high common-mode rejection specifications.

The FOD8160, packaged in a wide-body SOP 5-Pin package, consists of an aluminium gallium arsenide (AlGaAs) LED and an integrated high-speed photodetector. The output of the detector IC is an open collector Schottky-clamped transistor. The electrical and switching characteristics are guaranteed over the extended industrial temperature range of -40°C to 100°C and a V_{CC} range of 3 V to 5.5 V.

Functional Schematic

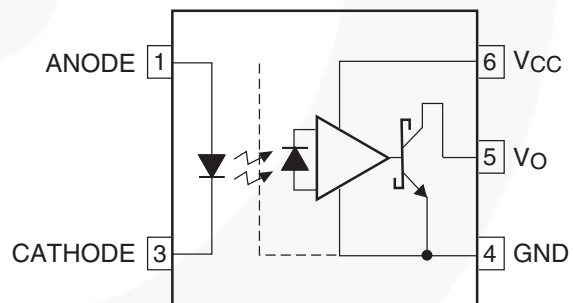


Figure 1. Functional Schematic

FOD8160 — High Noise Immunity, 3.3 V / 5 V, 10 Mbit/sec, Logic Gate Optocoupler in Wide-Body SOP 5-Pin

Truth Table

LED	Output
Off	HIGH
On	LOW

Pin Configuration

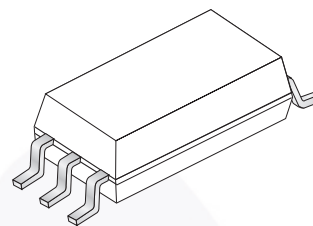
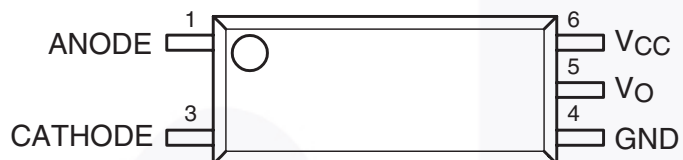


Figure 2. Pin Configuration

Pin Definitions

Pin #	Name	Description
1	Anode	Anode
3	Cathode	Cathode
4	GND	Output Ground
5	V _O	Output Voltage
6	V _{CC}	Output Supply Voltage

Safety and Insulation Ratings

As per DIN EN/IEC60747-5-5, this optocoupler is suitable for “safe electrical insulation” only within the safety limit data below. Compliance with the safety ratings shall be ensured by means of protective circuits.

Symbol	Parameter	Min.	Typ.	Max.	Unit
	Installation Classifications per DIN VDE 0110/1.89 Table 1				
	For Rated Mains Voltage < 150 V _{RMS}		I-IV		
	For Rated Mains Voltage < 300 V _{RMS}		I-IV		
	For Rated Mains Voltage < 450 V _{RMS}		I-IV		
	For Rated Mains Voltage < 600 V _{RMS}		I-IV		
	Climatic Classification		40/100/21		
	Pollution Degree (DIN VDE 0110/1.89)		2		
CTI	Comparative Tracking Index	175			
V _{PR}	Input to Output Test Voltage, Method b, V _{IORM} × 1.875 = V _{PR} , 100% Production Test with t _m = 1 s, Partial Discharge < 5 pC	2651			V _{peak}
	Input to Output Test Voltage, Method a, V _{IORM} × 1.6 = V _{PR} , Type and Sample Test with t _m = 10 s, Partial Discharge < 5 pC	2262			V _{peak}
V _{IORM}	Maximum Working Insulation Voltage	1414			V _{peak}
V _{IOTM}	Highest Allowable Over Voltage	8000			V _{peak}
	External Creepage	10.0			mm
	External Clearance	10.0			mm
	Insulation Thickness	0.5			mm
	Safety Limit Values – Maximum Values Allowed in the Event of a Failure				
T _S	Case Temperature	150			°C
I _{S,INPUT}	Input Current	200			mA
P _{S,OUTPUT}	Output Power	600			mW
R _{IO}	Insulation Resistance at T _S , V _{IO} = 500 V	10 ⁹			Ω

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $T_A = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	Value	Units
T_{STG}	Storage Temperature	-40 to +125	$^\circ\text{C}$
T_{OPR}	Operating Temperature	-40 to +100	$^\circ\text{C}$
T_J	Junction Temperature	-40 to +125	$^\circ\text{C}$
T_{SOL}	Lead Solder Temperature (Refer to Reflow Temperature Profile on page 12)	260 for 10 seconds	$^\circ\text{C}$
Input Characteristics			
I_F	Average Forward Input Current	25	mA
V_R	Reverse Input Voltage	5.0	V
PD_I	Input Power Dissipation ⁽¹⁾	45	mW
Output Characteristics			
V_{CC}	Supply Voltage	0 to 7.0	V
V_O	Output Voltage	-0.5 to $V_{CC} + 0.5$	V
I_O	Average Output Current	50	mA
PD_O	Output Power Dissipation ⁽¹⁾	85	mW

Note:

1. No derating required up to 100°C .

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit
T_A	Ambient Operating Temperature	-40	+100	$^\circ\text{C}$
V_{CC}	Supply Voltages ⁽²⁾	3.0	5.5	V
V_{FL}	Logic Low Input Voltage	0	0.8	V
I_{FL}	Logic Low Input Current		250	μA
I_{FH}	Logic High Input Current	6.0	15	mA
N	Fan Out (at $R_L = 1\text{ k}\Omega$)		5	TTL loads
R_L	Output Pull-up Resistor	330	4000	Ω

Note:

2. $0.1\ \mu\text{F}$ bypass capacitor must be connected between pins 4 and 6.

Isolation Characteristics

Apply over all recommended conditions, typical value is measured at $T_A = 25^\circ\text{C}$.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
V_{ISO}	Input-Output Isolation Voltage	$T_A = 25^\circ\text{C}$, R.H. < 50%, $t = 1.0$ min, $I_{I-O} \leq 20 \mu\text{A}^{(3)(4)}$	5,000			VAC_{RMS}
R_{ISO}	Isolation Resistance	$V_{I-O} = 500 \text{ V}^{(3)}$		10^{11}		Ω
C_{ISO}	Isolation Capacitance	$V_{I-O} = 0 \text{ V}$, frequency = $1.0 \text{ MHz}^{(3)}$		1.0		pF

Notes:

- Device is considered a two-terminal device: pins 1 and 3 are shorted together and pins 4, 5, and 6 are shorted together.
- 5,000 VAC_{RMS} for 1-minute duration is equivalent to 6,000 VAC_{RMS} for 1-second duration.

Electrical Characteristics

Apply over all recommended conditions; $T_A = -40^\circ\text{C}$ to $+100^\circ\text{C}$, $3.0 \text{ V} \leq V_{CC} \leq 5.5 \text{ V}$; unless otherwise specified. Typical value is measured at $T_A = 25^\circ\text{C}$ and $V_{CC} = 3.3 \text{ V}$ or $V_{CC} = 5 \text{ V}$.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units	Figure
Input Characteristics							
V_F	Forward Voltage	$I_F = 10 \text{ mA}$	1.05	1.45	1.80	V	3
$\Delta(V_F / T_A)$	Temperature Coefficient of Forward Voltage			-1.8		mV/°C	
BV_R	Input Reverse Breakdown Voltage	$I_R = 10 \mu\text{A}$	5.0			V	
I_{FHL}	Threshold Input Current	$V_O = 0.6 \text{ V}$, $I_{OL}(\text{sink}) = 13 \text{ mA}$		2.5	6.0	mA	4
Output Characteristics							
V_{OL}	Logic Low Output Voltage	$I_F = \text{rated } I_{FHL}$, $I_{OL}(\text{sink}) = 13 \text{ mA}$		0.4	0.6	V	5
I_{OH}	Logic High Output Current	$I_F = 250 \mu\text{A}$, $V_O = 3.3 \text{ V}$		8.0	50.0	μA	6
		$I_F = 250 \mu\text{A}$, $V_O = 5.0 \text{ V}$		3.0	40.0	μA	6
I_{CCL}	Logic Low Output Supply Current	$I_F = 10 \text{ mA}$, $V_{CC} = 3.3 \text{ V}$		5.3	8.5	mA	7, 9
		$I_F = 10 \text{ mA}$, $V_{CC} = 5.0 \text{ V}$		7.1	10.0	mA	7, 9
I_{CCH}	Logic High Output Supply Current	$I_F = 0 \text{ mA}$, $V_{CC} = 3.3 \text{ V}$		3.5	7.0	mA	8, 9
		$I_F = 0 \text{ mA}$, $V_{CC} = 5.0 \text{ V}$		5.3	9.0	mA	8, 9

Switching Characteristics

Apply over all recommended conditions; $T_A = -40^\circ\text{C}$ to $+100^\circ\text{C}$, $V_{CC} = 3.3\text{ V}$, $I_F = 6.0\text{ mA}$; unless otherwise specified. Typical value is measured at $T_A = 25^\circ\text{C}$ and $V_{CC} = 3.3\text{ V}$.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units	Figure
Data Rate		$R_L = 350\ \Omega$			10	Mbit/sec	
t_{PHL}	Propagation Delay to Logic Low Output	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		40	80	ns	10, 11, 15
t_{PLH}	Propagation Delay to Logic High Output	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		50	90	ns	10, 11, 15
PWD	Pulse Width Distortion, $ t_{PHL} - t_{PLH} $	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		10	35	ns	12, 13, 15
t_{PSK}	Propagation Delay Skew	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$ ⁽⁵⁾			40	ns	
t_R	Output Rise Time (10% to 90%)	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		20		ns	14, 15
t_F	Output Fall Time (90% to 10%)	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		10		ns	14, 15
$ CM_H $	Common-Mode Transient Immunity at Output High	$I_F = 0\text{ mA}$, $V_O > 2\text{ V}$, $V_{CM} = 1,000\text{ V}^{(6)}$	20	40		kV/ μs	16
$ CM_L $	Common-Mode Transient Immunity at Output Low	$I_F = 6.0\text{ mA}$, $V_O < 0.8\text{ V}$, $V_{CM} = 1,000\text{ V}^{(6)}$	20	40		kV/ μs	16

Apply over all recommended conditions; $T_A = -40^\circ\text{C}$ to $+100^\circ\text{C}$, $V_{CC} = 5\text{ V}$, $I_F = 6.0\text{ mA}$; unless otherwise specified. Typical value is measured at $T_A = 25^\circ\text{C}$ and $V_{CC} = 5\text{ V}$.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units	Figure
Data Rate		$R_L = 350\ \Omega$			10	Mbit/sec	
t_{PHL}	Propagation Delay to Logic Low Output	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		37	80	ns	10, 11, 15
t_{PLH}	Propagation Delay to Logic High Output	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		41	90	ns	10, 11, 15
PWD	Pulse Width Distortion, $ t_{PHL} - t_{PLH} $	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		4	25	ns	12, 13, 15
t_{PSK}	Propagation Delay Skew	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}^{(5)}$			40	ns	
t_R	Output Rise Time (10% to 90%)	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		22		ns	14, 15
t_F	Output Fall Time (90% to 10%)	$R_L = 350\ \Omega$, $C_L = 15\text{ pF}$		9		ns	14, 15
$ CM_H $	Common-Mode Transient Immunity at Output High	$I_F = 0\text{ mA}$, $V_O > 2\text{ V}$, $V_{CM} = 1,000\text{ V}^{(6)}$	20	40		kV/ μs	16
$ CM_L $	Common-Mode Transient Immunity at Output Low	$I_F = 6.0\text{ mA}$, $V_O < 0.8\text{ V}$, $V_{CM} = 1,000\text{ V}^{(6)}$	20	40		kV/ μs	16

Notes:

5. t_{PSK} is equal to the magnitude of the worst-case difference in t_{PHL} and/or t_{PLH} between any two units from the same manufacturing date code that are operated at same case temperature ($\pm 5^{\circ}\text{C}$), at same operating conditions, with equal loads ($R_L = 350\ \Omega$, $C_L = 15\ \text{pF}$), and with an input rise time less than 5 ns.
6. Common-mode transient immunity at output HIGH is the maximum tolerable positive dV_{cm}/dt on the leading edge of the common-mode impulse signal, V_{CM} , to assure that the output remains HIGH. Common-mode transient immunity at output LOW is the maximum tolerable negative dV_{cm}/dt on the trailing edge of the common pulse signal, V_{CM} , to assure that the output remains LOW.

Typical Performance Characteristics

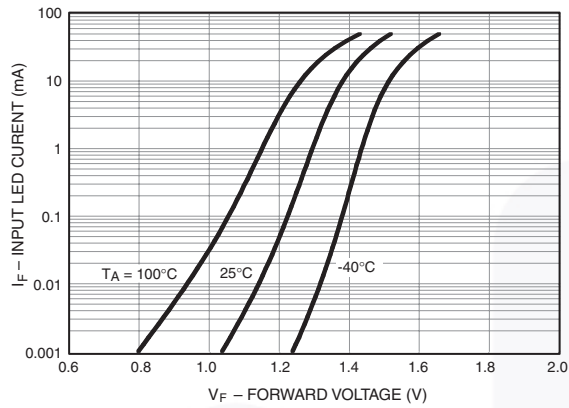


Figure 3. Input LED Current (I_F) vs. Forward Voltage (V_F)

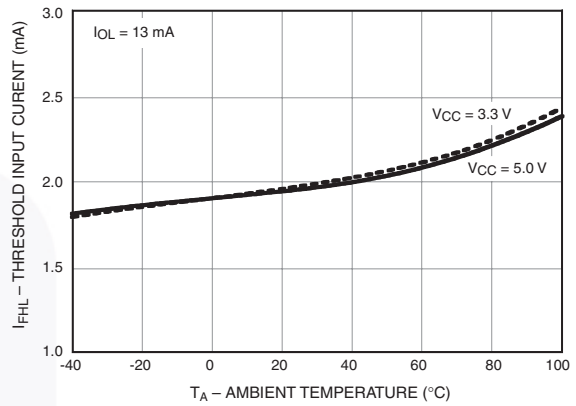


Figure 4. Threshold Input Current (I_{FHL}) vs. Ambient Temperature

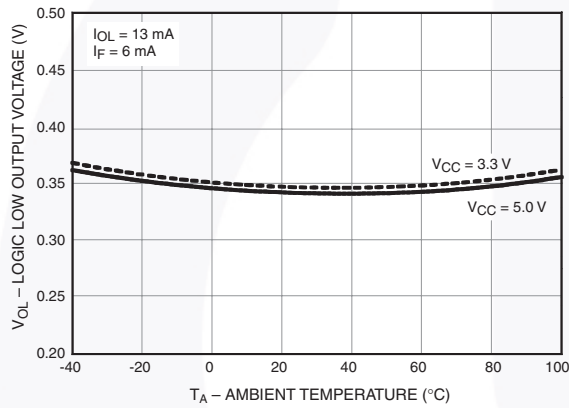


Figure 5. Logic Low Output Voltage (V_{OL}) vs. Ambient Temperature

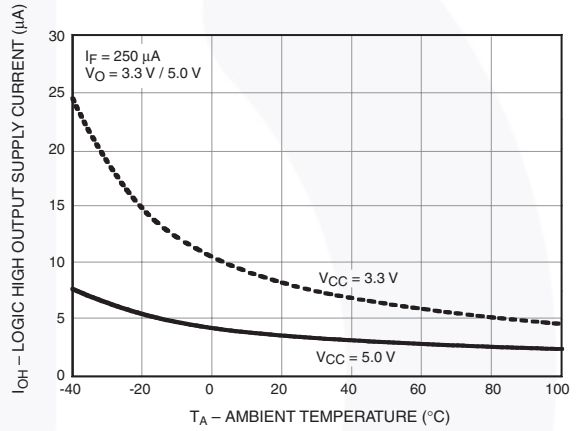


Figure 6. Logic High Output Current (I_{OH}) vs. Ambient Temperature

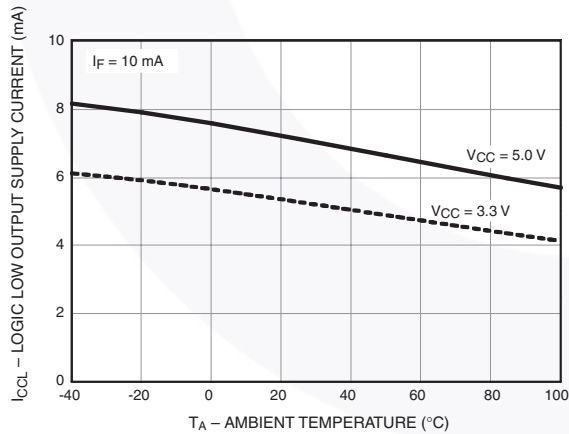


Figure 7. Logic Low Output Supply Current (I_{CCL}) vs. Ambient Temperature

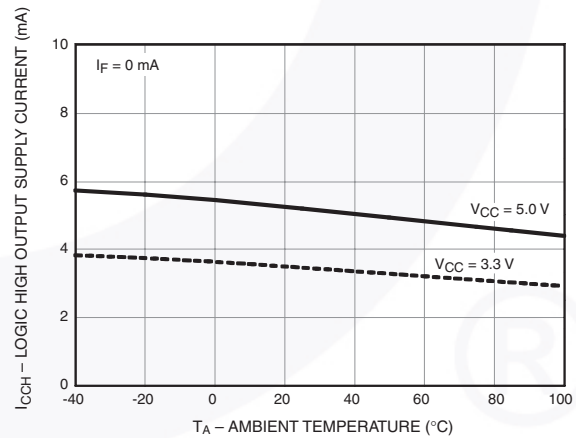


Figure 8. Logic High Output Supply Current (I_{CCH}) vs. Ambient Temperature

Typical Performance Characteristics (Continued)

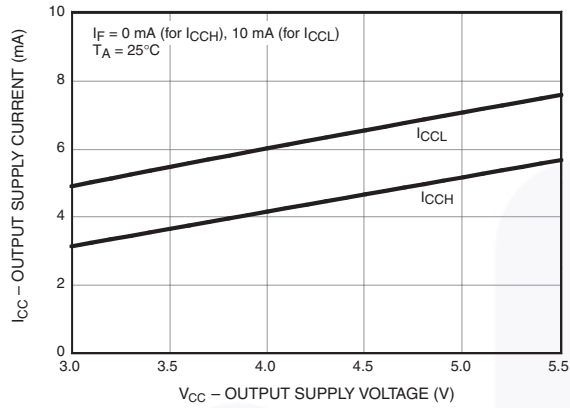


Figure 9. Output Supply Current (I_{CC}) vs. Output Supply Voltage (V_{CC})

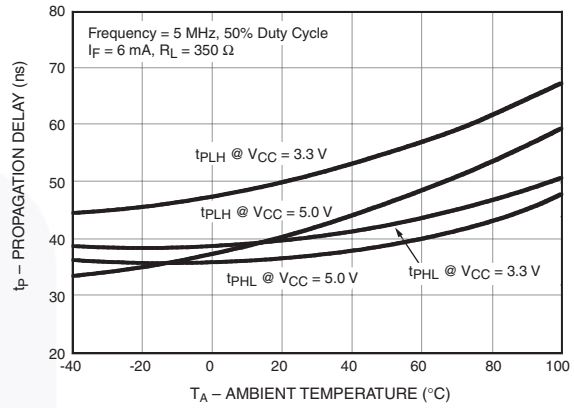


Figure 10. Propagation Delay vs. Ambient Temperature

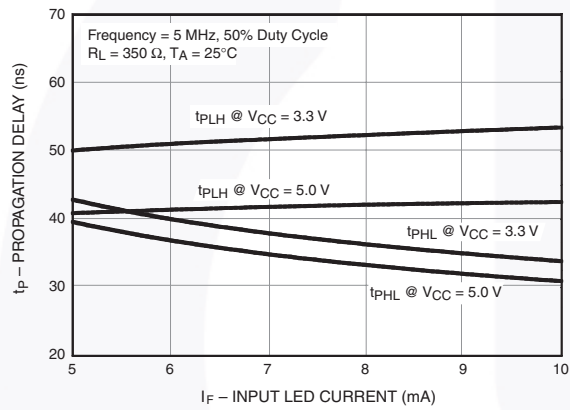


Figure 11. Propagation Delay vs. Input LED Current (I_F)

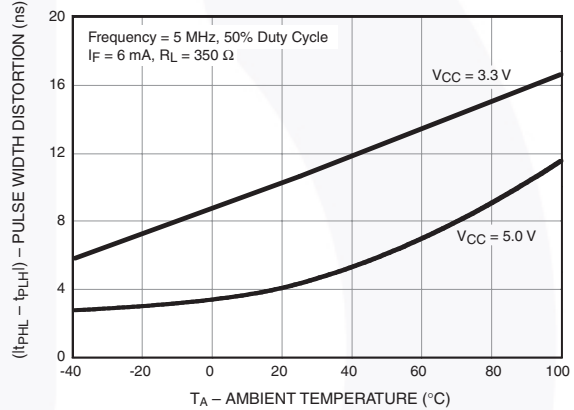


Figure 12. Pulse Width Distortion vs. Ambient Temperature

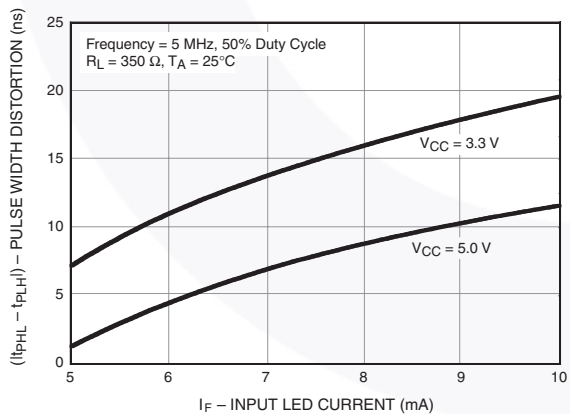


Figure 13. Pulse Width Distortion vs. Input LED Current (I_F)

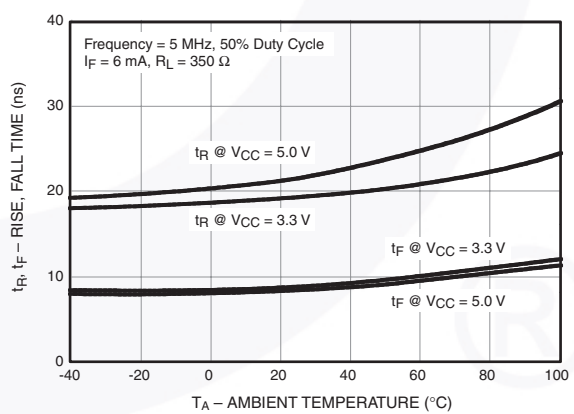


Figure 14. Rise Time (t_r) and Fall Time (t_f) vs. Ambient Temperature

Test Circuit

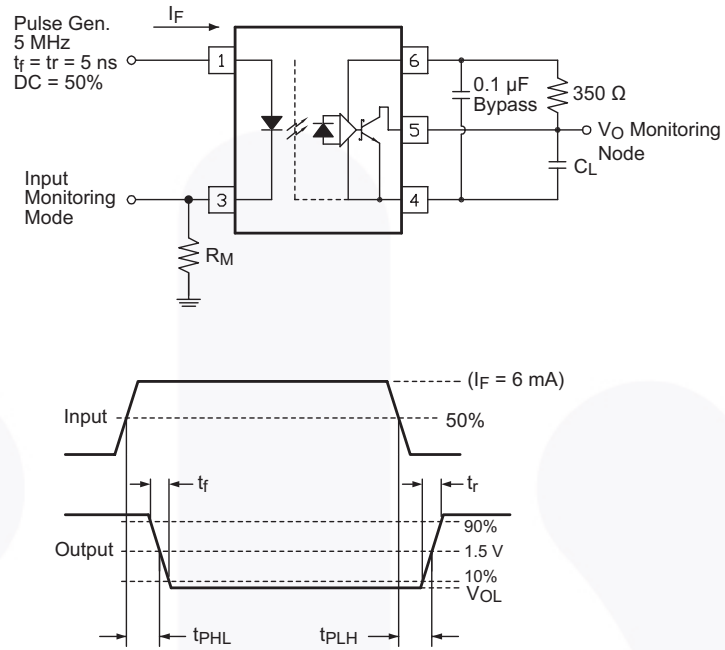


Figure 15. Test Circuit for Propagation Delay, Rise Time, and Fall Time

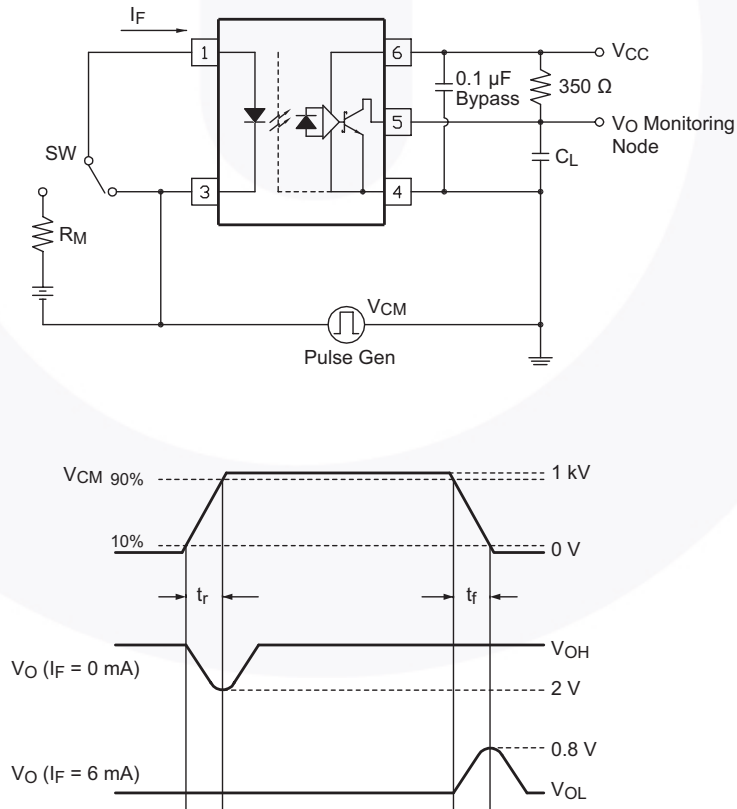



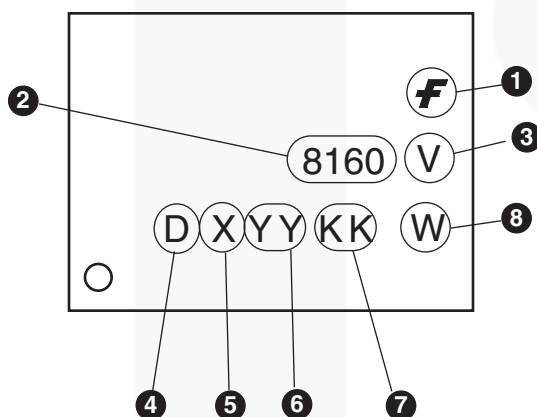
Figure 16. Test Circuit for Instantaneous Common-Mode Rejection Voltage

Ordering Information

Part Number	Package	Packing Method
FOD8160	Wide Body SOP 5-Pin	Tube (100 units per tube)
FOD8160R2	Wide Body SOP 5-Pin	Tape and Reel (1,000 units per reel)
FOD8160V	Wide Body SOP 5-Pin, DIN EN/IEC60747-5-5 Option	Tube (100 units per tube)
FOD8160R2V	Wide Body SOP 5-Pin, DIN EN/ IEC60747-5-5 Option	Tape and Reel (1,000 units per reel)

 All packages are lead free per JEDEC: J-STD-020B standard.

Marking Information



Definitions

1	Fairchild logo
2	Device number, e.g., '8160' for FOD8160
3	DIN EN/IEC60747-5-5 option (only appears on component ordered with this option)
4	Plant code, e.g., 'D'
5	Last-digit year code, e.g., 'E' for 2014
6	Two-digit work week ranging from '01' to '53'
7	Lot-traceability code
8	Package assembly code, W

Reflow Profile

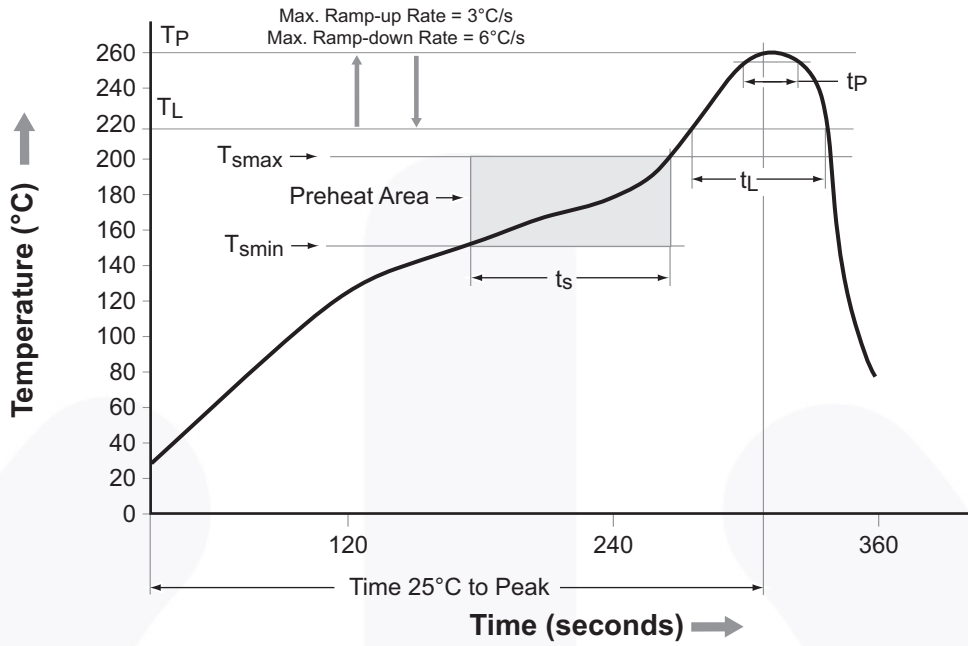
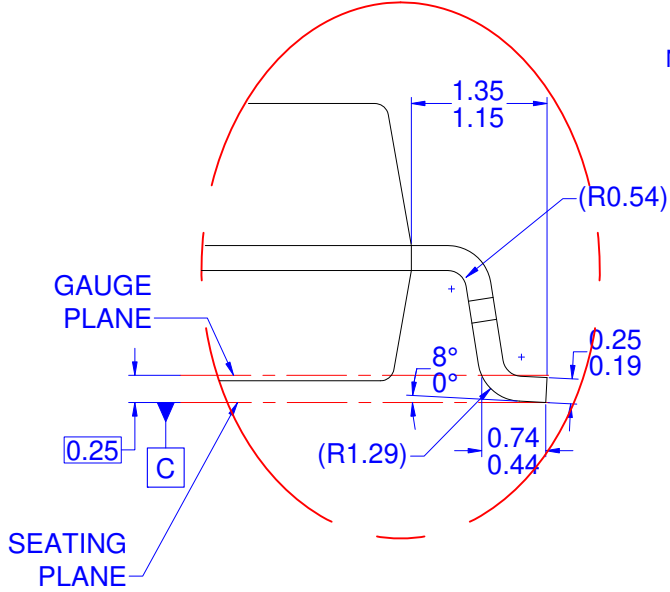
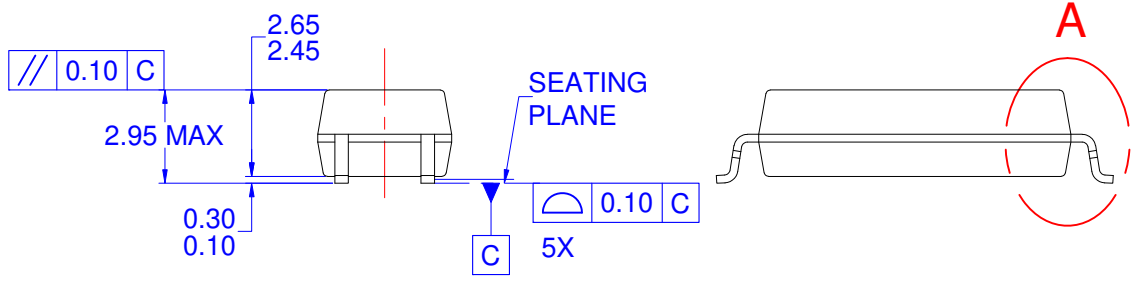
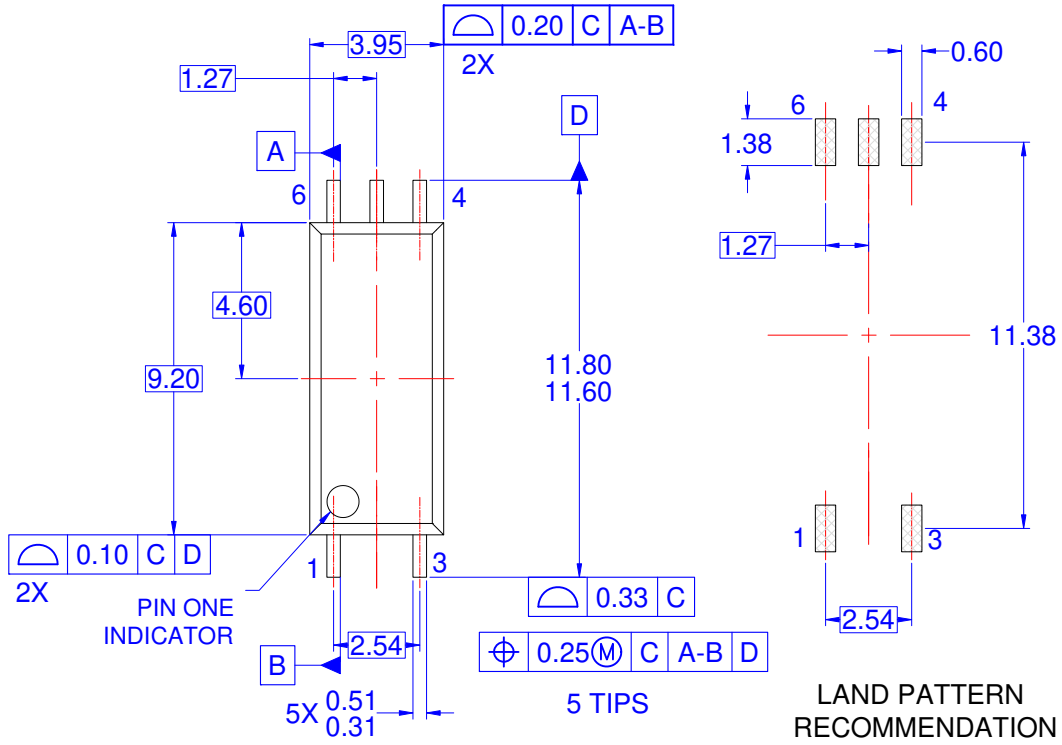


Figure 17. Reflow Profile

Profile Feature	Pb-Free Assembly Profile
Temperature Minimum (T_{smin})	150°C
Temperature Maximum (T_{smax})	200°C
Time (t_s) from (T_{smin} to T_{smax})	60 to 120 seconds
Ramp-Up Rate (t_L to t_P)	3°C/second maximum
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60 to 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t_P) within 5°C of 260°C	30 seconds
Ramp-Down Rate (T_P to T_L)	6°C/second maximum
Time 25°C to Peak Temperature	8 minutes maximum



DETAIL A
SCALE: 3.2:1

NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE DOES NOT CONFORM TO ANY STANDARD.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS
- D) DRAWING CONFORMS TO ASME Y14.5M-1994
- E) DRAWING FILE NAME: MKT-M05AREV3

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>
For additional information, please contact your local
Sales Representative